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**PRELIMINARY**

# ICS8422004I

## FEMTOCLOCKS™ LVCMOS/CRYSTAL-TO-LVHSTL FREQUENCY SYNTHESIZER

### GENERAL DESCRIPTION



The ICS8422004I is a 4 output LVHSTL Synthesizer optimized to generate Fibre Channel reference clock frequencies and is a member of the HiPerClocks™ family of high performance clock solutions from ICS. Using a 26.5625MHz 18pF parallel resonant crystal, the following frequencies can be generated based on the 2 frequency select pins (F\_SEL[1:0]): 212.5MHz, 187.5MHz, 159.375MHz, 156.25, 106.25MHz and 53.125MHz. The ICS8422004I uses ICS' 3<sup>rd</sup> generation low phase noise VCO technology and can achieve 1ps or lower typical rms phase jitter, easily meeting Fibre Channel jitter requirements. The ICS8422004I is packaged in a small 24-pin TSSOP package.

### FEATURES

- Four LVHSTL outputs (VOHmax = 1.2V)
- Selectable crystal oscillator interface or LVCMOS/LVTTL single-ended input
- Supports the following output frequencies: 212.5MHz, 187.5MHz, 159.375MHz, 156.25, 106.25MHz, 53.125MHz
- VCO range: 560MHz - 680MHz
- RMS phase jitter @ 212.5MHz, using a 26.5625MHz crystal (637kHz - 10MHz): 0.59ps (typical)
- Power supply modes:  
Core/Output  
3.3V/1.8V  
2.5V/1.8V
- -40°C to 85°C ambient operating temperature
- Available in both standard and lead-free RoHS-compliant packages

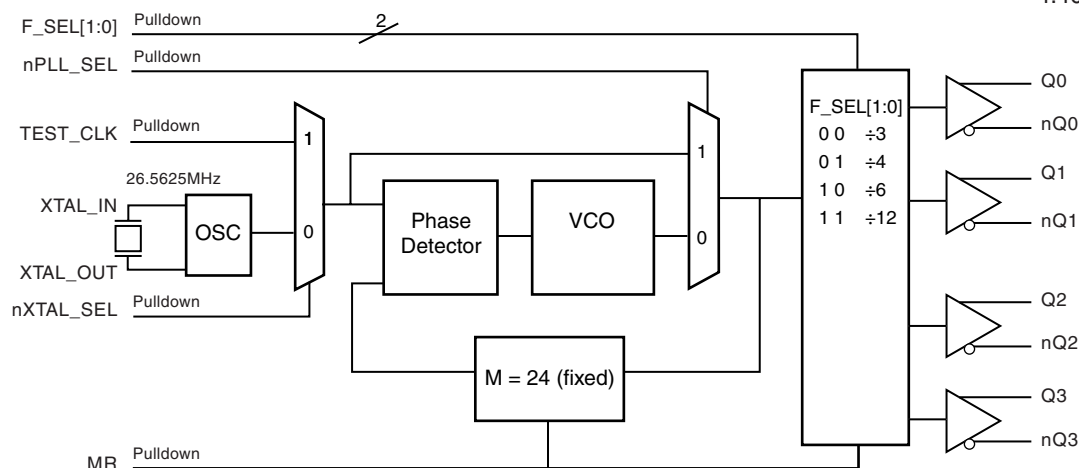
**FREQUENCY SELECT FUNCTION TABLE**

Input Frequency (MHz)	Inputs					Output Frequency (MHz)
	F_SEL1	F_SEL0	M Divider Value	N Divider Value	M/N Divider Value	
26.5625	0	0	24	3	8	212.5
26.5625	0	1	24	4	6	159.375
26.5625	1	0	24	6	4	106.25
26.5625	1	1	24	12	2	53.125
26.04166	0	1	24	4	6	156.25
23.4375	0	0	24	3	8	187.5

### PIN ASSIGNMENT

nQ1	1	24	nQ2
Q1	2	23	Q2
VDDO	3	22	VDDO
Q0	4	21	Q3
nQ0	5	20	nQ3
MR	6	19	GND
nPLL_SEL	7	18	nc
nc	8	17	nXTAL_SEL
VDDA	9	16	TEST_CLK
F_SEL0	10	15	GND
VDD	11	14	XTAL_IN
F_SEL1	12	13	XTAL_OUT

### BLOCK DIAGRAM



### ICS8422004I

#### 24-Lead TSSOP

4.40mm x 7.8mm x 0.92mm  
package body  
**G Package**  
Top View

The Preliminary Information presented herein represents a product in prototyping or pre-production. The noted characteristics are based on initial product characterization. Integrated Circuit Systems, Incorporated (ICS) reserves the right to change any circuitry or specifications without notice.



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**TABLE 1. PIN DESCRIPTIONS**

Number	Name	Type		Description
1, 2	nQ1, Q1	Output		Differential output pair. LVHSTL interface levels.
3, 22	V <sub>DDO</sub>	Power		Output supply pins.
4, 5	Q0, nQ0	Output		Differential output pair. LVHSTL interface levels.
6	MR	Input	Pulldown	Active HIGH Master Reset. When logic HIGH, the internal dividers are reset causing the true outputs Qx to go low and the inverted outputs nQx to go high. When logic LOW, the internal dividers and the outputs are enabled. LVCMOS/LVTTL interface levels.
7	nPLL_SEL	Input	Pulldown	Selects between the PLL and TEST_CLK as input to the dividers. When LOW, selects PLL (PLL Enable). When HIGH, deselects the reference clock (PLL Bypass). LVCMOS/LVTTL interface levels.
8, 18	nc	Unused		No connect.
9	V <sub>DDA</sub>	Power		Analog supply pin.
10, 12	F_SEL0, F_SEL1	Input	Pulldown	Frequency select pins. LVCMOS/LVTTL interface levels.
11	V <sub>DD</sub>	Power		Core supply pin.
13, 14	XTAL_OUT, XTAL_IN	Input		Parallel resonant crystal interface. XTAL_OUT is the output, XTAL_IN is the input.
15, 19	GND	Power		Power supply ground.
16	TEST_CLK	Input	Pulldown	LVCMOS/LVTTL clock input.
17	nXTAL_SEL	Input	Pulldown	Selects between crystal or TEST_CLK inputs as the the PLL Reference source. Selects XTAL inputs when LOW. Selects TEST_CLK when HIGH. LVCMOS/LVTTL interface levels.
20, 21	nQ3, Q3	Output		Differential output pair. LVHSTL interface levels.
23, 24	Q2, nQ2	Output		Differential output pair. LVHSTL interface levels.

NOTE: *Pulldown* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

**TABLE 2. PIN CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C <sub>IN</sub>	Input Capacitance			4		pF
R <sub>PULLDOWN</sub>	Input Pulldown Resistor			51		kΩ



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### ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{DD}$	4.6V
Inputs, $V_I$	-0.5V to $V_{DD} + 0.5V$
Outputs, $I_O$	
Continuous Current	50mA
Surge Current	100mA
Package Thermal Impedance, $\theta_{JA}$	70°C/W (0 mps)
Storage Temperature, $T_{STG}$	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

**TABLE 3A. POWER SUPPLY DC CHARACTERISTICS,  $V_{DD} = V_{DDA} = 3.3V \pm 5\%$ ,  $V_{DDO} = 1.8V \pm 0.2V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{DD}$	Core Supply Voltage		3.135	3.3	3.465	V
$V_{DDA}$	Analog Supply Voltage		3.135	3.3	3.465	V
$V_{DDO}$	Output Supply Voltage		1.6	1.8	2.0	V
$I_{DD}$	Power Supply Current			90		mA
$I_{DDA}$	Analog Supply Current			10		mA
$I_{DDO}$	Output Supply Current	No Load		0		mA

**TABLE 3B. POWER SUPPLY DC CHARACTERISTICS,  $V_{DD} = V_{DDA} = 2.5V \pm 5\%$ ,  $V_{DDO} = 1.8V \pm 0.2V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{DD}$	Core Supply Voltage		2.375	2.5	2.625	V
$V_{DDA}$	Analog Supply Voltage		2.375	2.5	2.625	V
$V_{DDO}$	Output Supply Voltage		1.6	1.8	2.0	V
$I_{DD}$	Power Supply Current			80		mA
$I_{DDA}$	Analog Supply Current			10		mA
$I_{DDO}$	Output Supply Current	No Load		0		mA

**TABLE 3C. LVCMOS / LVTTTL DC CHARACTERISTICS,  $V_{DD} = V_{DDA} = 3.3V \pm 5\%$  OR  $2.5V \pm 5\%$ ,  $V_{DDO} = 1.8V \pm 0.2V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{IH}$	Input High Voltage	$V_{DD} = 3.3V$	2		$V_{DD} + 0.3$	V
		$V_{DD} = 2.5V$	1.7		$V_{DD} + 0.3$	V
$V_{IL}$	Input Low Voltage	$V_{DD} = 3.3V$	-0.3		0.8	V
		$V_{DD} = 2.5V$	-0.3		0.7	V
$I_{IH}$	Input High Current	TEST_CLK, MR, F_SEL0, F_SEL1, nPLL_SEL, nXTAL_SEL $V_{DD} = V_{IN} = 3.465V$ or 2.5V			150	$\mu A$
$I_{IL}$	Input Low Current	TEST_CLK, MR, F_SEL0, F_SEL1, nPLL_SEL, nXTAL_SEL $V_{DD} = 3.465V$ or 2.5V, $V_{IN} = 0V$	-150			$\mu A$



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**TABLE 3D. LVHSTL DC CHARACTERISTICS**,  $V_{DD} = V_{DDA} = 3.3V \pm 5\%$ ,  $V_{DDO} = 1.8V \pm 0.2V$ ,  $T_A = -40^\circ\text{C}$  TO  $85^\circ\text{C}$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{OH}$	Output High Voltage; NOTE 1		1.0		1.2	V
$V_{OL}$	Output Low Voltage; NOTE 1		0		0.4	V
$V_{OX}$	Output Crossover Voltage; NOTE 2		40		60	%
$V_{SWING}$	Peak-to-Peak Output Voltage Swing		0.6		1.1	V

NOTE 1: Outputs terminated with  $50\Omega$  to ground.

NOTE 2: Defined with respect to output voltage swing at a given condition.

**TABLE 3E. LVHSTL DC CHARACTERISTICS**,  $V_{DD} = V_{DDA} = 2.5V \pm 5\%$ ,  $V_{DDO} = 1.8V \pm 0.2V$ ,  $T_A = -40^\circ\text{C}$  TO  $85^\circ\text{C}$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{OH}$	Output High Voltage; NOTE 1		1.0		1.2	V
$V_{OL}$	Output Low Voltage; NOTE 1			0.235		V
$V_{OX}$	Output Crossover Voltage; NOTE 2		40		60	%
$V_{SWING}$	Peak-to-Peak Output Voltage Swing			0.9		V

NOTE 1: Outputs terminated with  $50\Omega$  to ground.

NOTE 2: Defined with respect to output voltage swing at a given condition.

**TABLE 4. CRYSTAL CHARACTERISTICS**

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fundamental			
Frequency		23.33	26.5625	28.33	MHz
Equivalent Series Resistance (ESR)				50	$\Omega$
Shunt Capacitance				7	pF
Drive Level				1	mW

NOTE: Characterized using an 18pF parallel resonant crystal.



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## FEMTOCLOCKS™ LVCMOS/CRYSTAL-TO-LVHSTL FREQUENCY SYNTHESIZER

**TABLE 5A. AC CHARACTERISTICS,  $V_{DD} = V_{DDA} = 3.3V \pm 5\%$ ,  $V_{DDO} = 1.8V \pm 0.2V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$f_{OUT}$	Output Frequency	F_SEL[1:0] = 00	186.67		226.66	MHz
		F_SEL[1:0] = 01	140		170	MHz
		F_SEL[1:0] = 10	93.33		113.33	MHz
		F_SEL[1:0] = 11	46.67		56.66	MHz
tsk(o)	Output Skew; NOTE 1, 3			TBD		ps
fjit( $\emptyset$ )	RMS Phase Jitter (Random); NOTE 2	212.5MHz, (637kHz - 10MHz)		0.59		ps
		187.5MHz, (637kHz - 10MHz)		0.53		ps
		159.375MHz, (637kHz - 10MHz)		0.56		ps
		156.25MHz, (1.875MHz - 20MHz)		0.50		ps
		106.25MHz, (1.875MHz - 20MHz)		0.56		ps
		53.125MHz, (637kHz - 10MHz)		0.66		ps
$t_R / t_F$	Output Rise/Fall Time	20% to 80%		410		ps
odc	Output Duty Cycle			50		%

NOTE 1: Defined as skew between outputs at the same supply voltages and with equal load conditions.  
Measured at  $V_{DDO}/2$ .

NOTE 2: Please refer to the Phase Noise Plot.

NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

**TABLE 5B. AC CHARACTERISTICS,  $V_{DD} = V_{DDA} = 2.5V \pm 5\%$ ,  $V_{DDO} = 1.8V \pm 0.2V$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$f_{OUT}$	Output Frequency	F_SEL[1:0] = 00	186.67		226.66	MHz
		F_SEL[1:0] = 01	140		170	MHz
		F_SEL[1:0] = 10	93.33		113.33	MHz
		F_SEL[1:0] = 11	46.67		56.66	MHz
tsk(o)	Output Skew; NOTE 1, 3			TBD		ps
fjit( $\emptyset$ )	RMS Phase Jitter (Random); NOTE 2	212.5MHz, (637kHz - 10MHz)		0.60		ps
		187.5MHz, (637kHz - 10MHz)		0.72		ps
		159.375MHz, (637kHz - 10MHz)		0.64		ps
		156.25MHz, (1.875MHz - 20MHz)		0.50		ps
		106.25MHz, (1.875MHz - 20MHz)		0.55		ps
		53.125MHz, (637kHz - 10MHz)		0.68		ps
$t_R / t_F$	Output Rise/Fall Time	20% to 80%		380		ps
odc	Output Duty Cycle			50		%

NOTE 1: Defined as skew between outputs at the same supply voltages and with equal load conditions.  
Measured at  $V_{DDO}/2$ .

NOTE 2: Please refer to the Phase Noise Plot.

NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

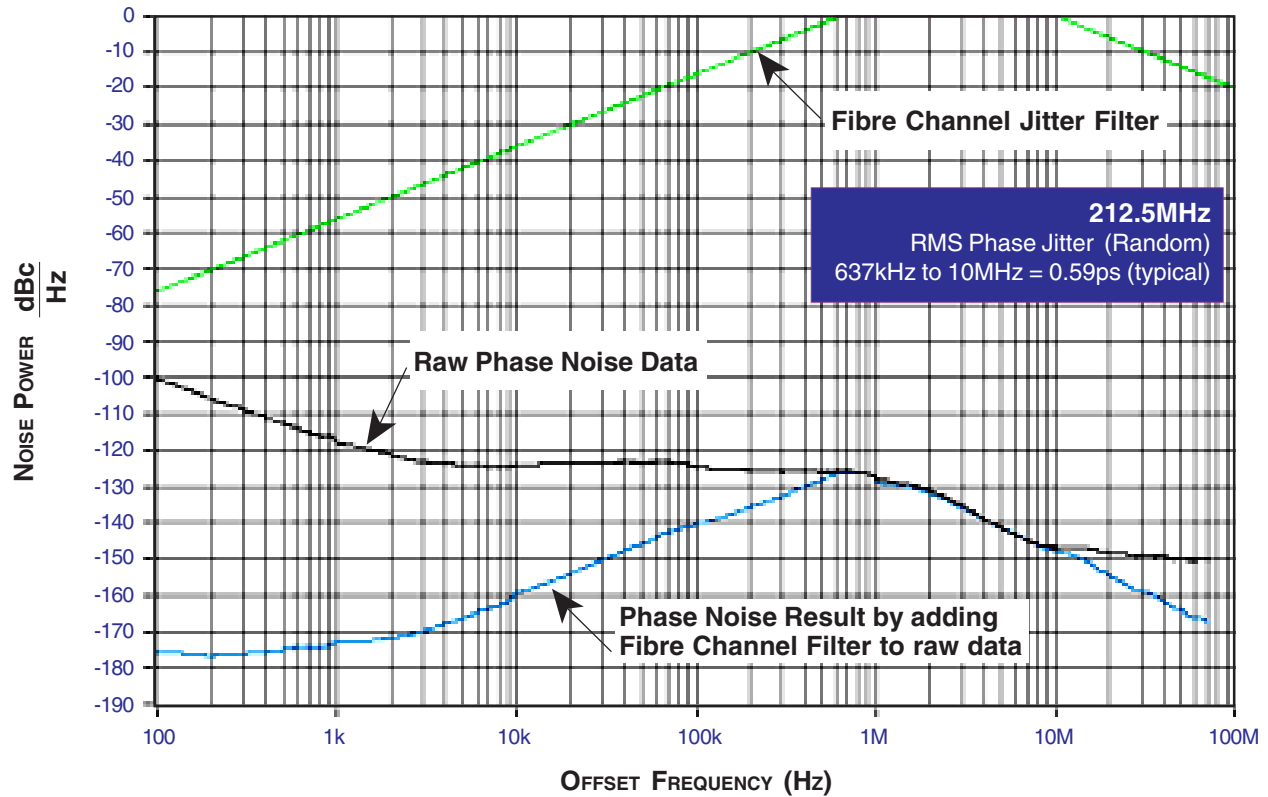


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### TYPICAL PHASE NOISE AT 212.5MHz



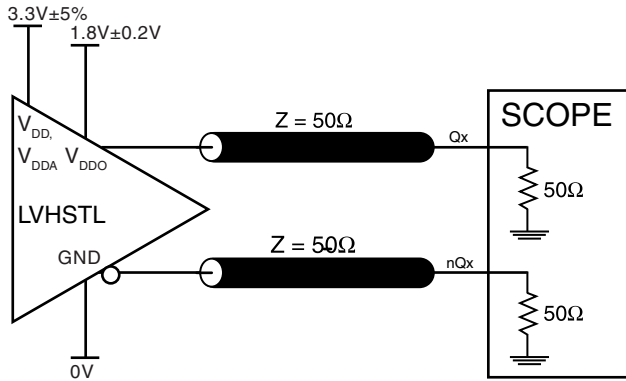


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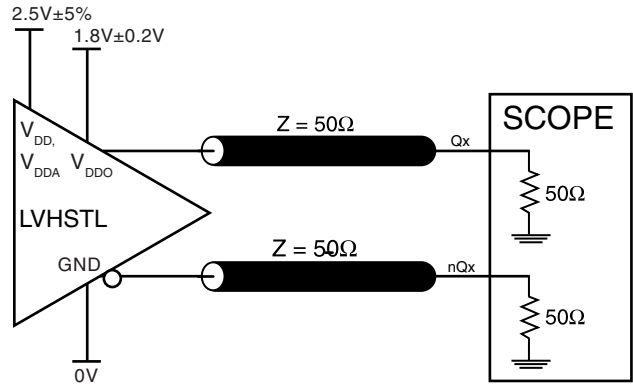
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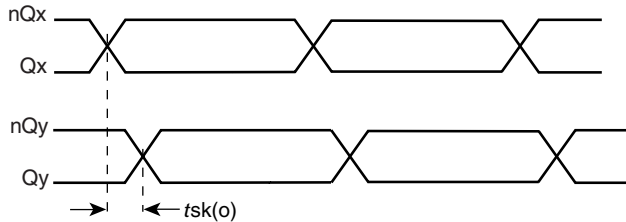
## PARAMETER MEASUREMENT INFORMATION



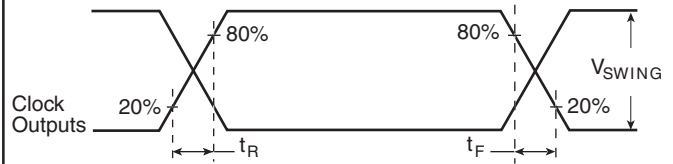
**LVHSTL 3.3V/1.8V OUTPUT LOAD AC TEST CIRCUIT**



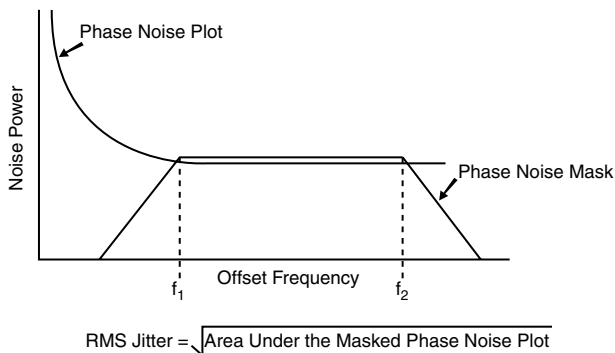
**LVHSTL 2.5V/1.8V OUTPUT LOAD AC TEST CIRCUIT**



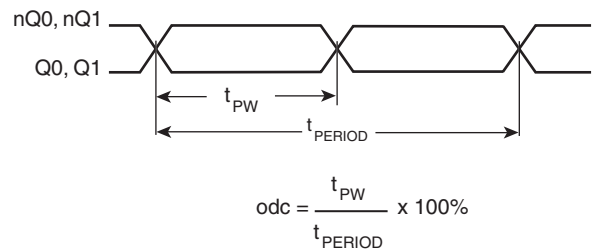
**OUTPUT SKEW**



**OUTPUT RISE/FALL TIME**



**RMS PHASE JITTER**



**OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD**



## APPLICATION INFORMATION

### POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS8422004I provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL.  $V_{DD}$ ,  $V_{DDA}$ , and  $V_{DDO}$  should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 1* illustrates how a  $10\Omega$  resistor along with a  $10\mu F$  and a  $.01\mu F$  bypass capacitor should be connected to each  $V_{DDA}$ .

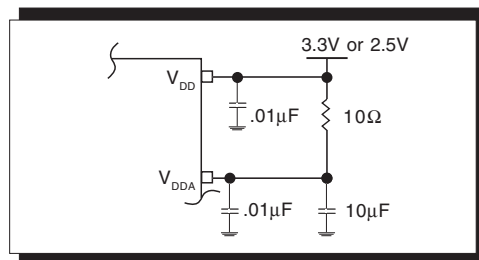


FIGURE 1. POWER SUPPLY FILTERING

### CRYSTAL INPUT INTERFACE

The ICS8422004I has been characterized with 18pF parallel resonant crystals. The capacitor values shown in *Figure 2*

below were determined using a 26.5625MHz 18pF parallel resonant crystal and were chosen to minimize the ppm error.

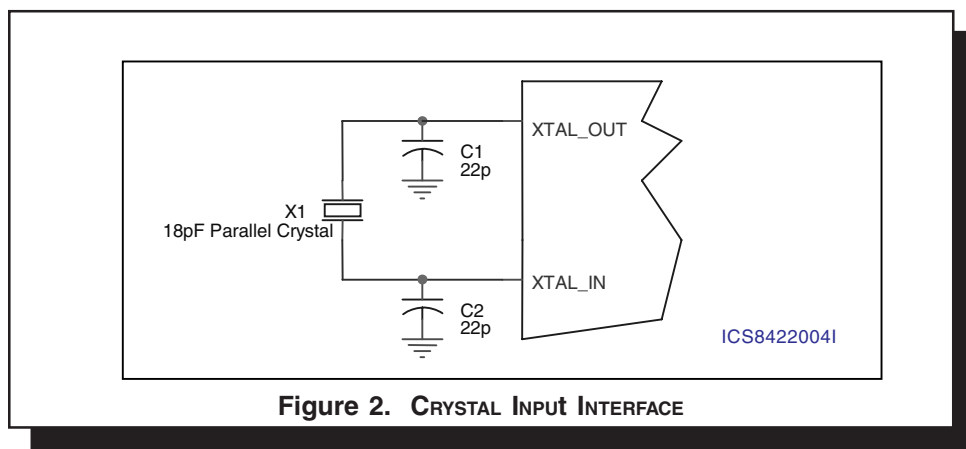


Figure 2. CRYSTAL INPUT INTERFACE

### RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

#### INPUTS:

##### CRYSTAL INPUT:

For applications not requiring the use of the crystal oscillator input, both XTAL\_IN and XTAL\_OUT can be left floating. Though not required, but for additional protection, a  $1k\Omega$  resistor can be tied from XTAL\_IN to ground.

##### TEST\_CLK INPUT:

For applications not requiring the use of the test clock, it can be left floating. Though not required, but for additional protection, a  $1k\Omega$  resistor can be tied from the TEST\_CLK to ground.

##### LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A  $1k\Omega$  resistor can be used.

#### OUTPUTS:

##### LVHSTL OUTPUT

All unused LVHSTL outputs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.





## POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS8422004I. Equations and example calculations are also provided.

### 1. Power Dissipation.

The total power dissipation for the ICS8422004I is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for  $V_{DD} = 3.3V + 5\% = 3.465V$ , which gives worst case results.

**NOTE:** Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)<sub>MAX</sub> =  $V_{DD\_MAX} * I_{DD\_MAX} = 3.465V * 100mA = 346.5mW$
- Power (outputs)<sub>MAX</sub> = **32.8mW/Loaded Output pair**  
If all outputs are loaded, the total power is  $4 * 32.8mW = 131.2mW$

$$\text{Total Power}_{MAX} (3.465V, \text{ with all outputs switching}) = 346.5mW + 131.2mW = 477.7mW$$

### 2. Junction Temperature.

Junction temperature,  $T_j$ , is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for  $T_j$  is as follows:  $T_j = \theta_{JA} * Pd\_total + T_A$

$T_j$  = Junction Temperature

$\theta_{JA}$  = Junction-to-Ambient Thermal Resistance

$Pd\_total$  = Total Device Power Dissipation (example calculation is in section 1 above)

$T_A$  = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming a moderate air flow of 1 meter per second and a multi-layer board, the appropriate value is 65°C/W per Table 6 below.

Therefore,  $T_j$  for an ambient temperature of 85°C with all outputs switching is:

$$85^\circ C + 0.478W * 65^\circ C/W = 99.85^\circ C. \text{ This is well below the limit of } 125^\circ C.$$

This calculation is only an example.  $T_j$  will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

**TABLE 6. THERMAL RESISTANCE  $\theta_{JA}$  FOR 24-PIN TSSOP, FORCED CONVECTION**

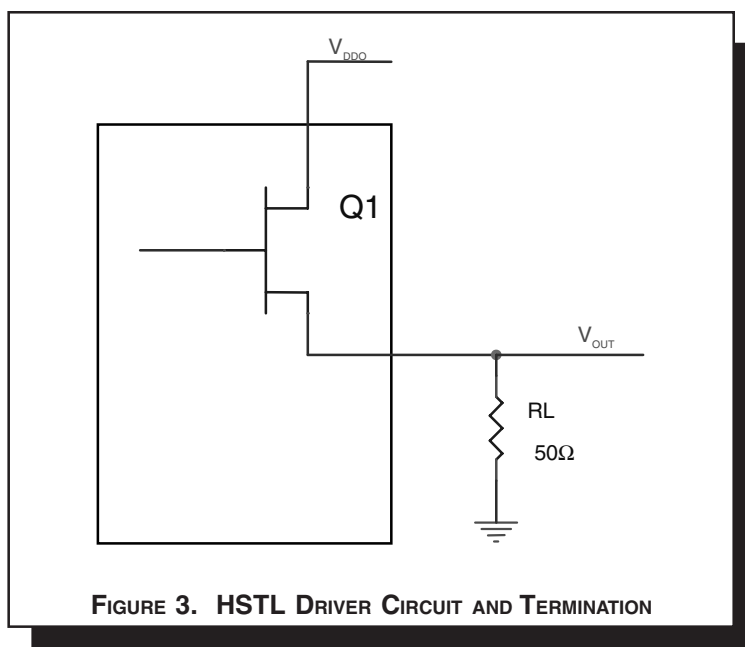
$\theta_{JA}$ by Velocity (Meters per Second)			
	0	1	2.5
Multi-Layer PCB, JEDEC Standard Test Boards	70°C/W	65°C/W	62°C/W



### 3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

HSTL output driver circuit and termination are shown in *Figure 3*.



To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load.

Pd\_H is power dissipation when the output drives high.

Pd\_L is the power dissipation when the output drives low.

$$Pd\_H = (V_{OH\_MIN} / R_L) * (V_{DD\_MAX} - V_{OH\_MIN})$$

$$Pd\_L = (V_{OL\_MAX} / R_L) * (V_{DD\_MAX} - V_{OL\_MAX})$$

$$Pd\_H = (1V/50\Omega) * (2V - 1V) = \mathbf{20mW}$$

$$Pd\_L = (0.4V/50\Omega) * (2V - 0.4V) = \mathbf{12.8mW}$$

$$\text{Total Power Dissipation per output pair} = Pd\_H + Pd\_L = \mathbf{32.8mW}$$



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## RELIABILITY INFORMATION

TABLE 7.  $\theta_{JA}$  VS. AIR FLOW TABLE FOR 24 LEAD TSSOP

$\theta_{JA}$ by Velocity (Meters per Second)			
	0	1	2.5
Multi-Layer PCB, JEDEC Standard Test Boards	70°C/W	65°C/W	62°C/W

### TRANSISTOR COUNT

The transistor count for ICS8422004I is: 2951

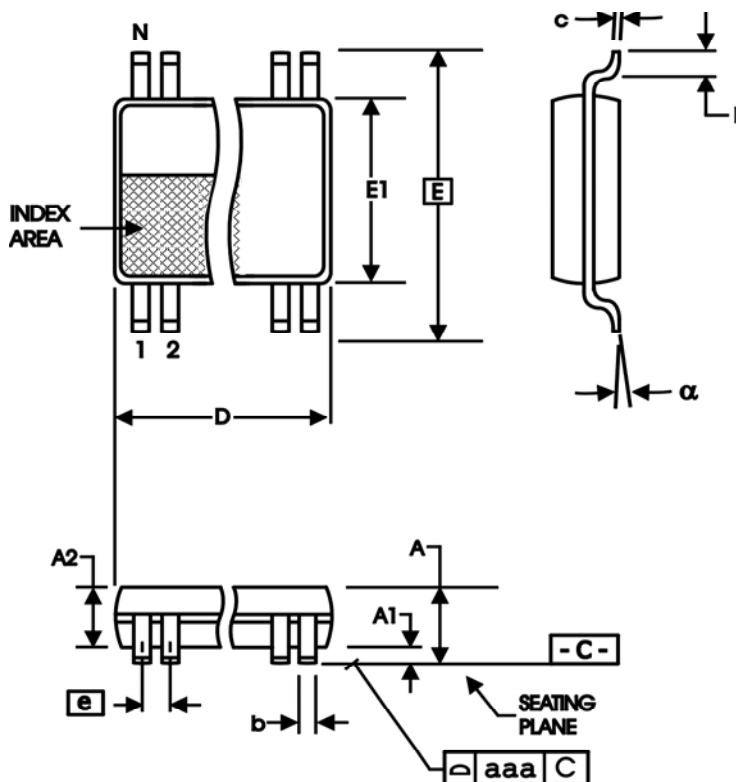


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**PACKAGE OUTLINE - G SUFFIX FOR 24 LEAD TSSOP**



**TABLE 8. PACKAGE DIMENSIONS**

SYMBOL	Millimeters	
	Minimum	Maximum
N	24	
A	--	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	7.70	7.90
E	6.40 BASIC	
E1	4.30	4.50
e	0.65 BASIC	
L	0.45	0.75
$\alpha$	0°	8°
aaa	--	0.10

Reference Document: JEDEC Publication 95, MO-153



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**TABLE 9. ORDERING INFORMATION**

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS8422004AGI	ICS8422004AGI	20 Lead TSSOP	tube	-40°C to 85°C
ICS8422004AGIT	ICS8422004AGI	20 Lead TSSOP	2500 tape & reel	-40°C to 85°C
ICS8422004AGILF	TBD	20 Lead "Lead-Free" TSSOP	tube	-40°C to 85°C
ICS8422004AGILFT	TBD	20 Lead "Lead-Free" TSSOP	2500 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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